



**ALPHA & OMEGA**  
SEMICONDUCTOR

# AOT12N65/AOTF12N65/AOB12N65

## 650V, 12A N-Channel MOSFET

### General Description

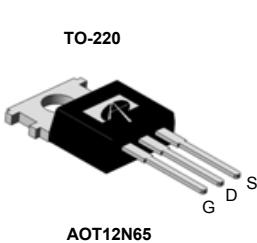
The AOT12N65 & AOTF12N65 & AOB12N65 have been fabricated using an advanced high voltage MOSFET process that is designed to deliver high levels of performance and robustness in popular AC-DC applications.

By providing low  $R_{DS(on)}$ ,  $C_{iss}$  and  $C_{rss}$  along with guaranteed avalanche capability these parts can be adopted quickly into new and existing offline power supply designs.

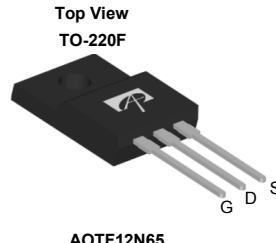
### Product Summary

$V_{DS}$	750V@150°C
$I_D$ (at $V_{GS}=10V$ )	12A
$R_{DS(ON)}$ (at $V_{GS}=10V$ )	< 0.72Ω

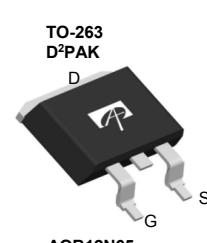
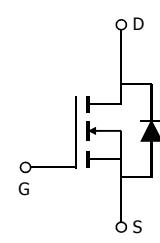
100% UIS Tested  
100%  $R_g$  Tested



TO-220



TO-220F

TO-263  
D<sup>2</sup>PAK

Orderable Part Number	Package Type	Form	Minimum Order Quantity
AOT12N65	TO-220 Pb Free	Tube	1000
AOTF12N65	TO-220F Pb Free	Tube	1000
AOTF12N65L	TO-220F Green	Tube	1000
AOB12N65L	TO-263 Green	Tape & Reel	800

### Absolute Maximum Ratings $T_A=25^\circ C$ unless otherwise noted

Parameter	Symbol	AOT(B)12N65	AOTF12N65	AOTF12N65L	Units
Drain-Source Voltage	$V_{DS}$		650		V
Gate-Source Voltage	$V_{GS}$		$\pm 30$		V
Continuous Drain Current $T_C=25^\circ C$	$I_D$	12	12*	12*	A
		7.7	7.7*	7.7*	
Pulsed Drain Current <sup>C</sup>	$I_{DM}$		48		
Avalanche Current <sup>C</sup>	$I_{AR}$		5		A
Repetitive avalanche energy <sup>C</sup>	$E_{AR}$		375		mJ
Single pulsed avalanche energy <sup>G</sup>	$E_{AS}$		750		mJ
MOSFET dv/dt ruggedness	dv/dt		30		V/ns
Peak diode recovery dv/dt			5		
Power Dissipation <sup>B</sup> $T_C=25^\circ C$	$P_D$	278	50	40	W
		2.2	0.4	0.3	W/ $^\circ C$
Junction and Storage Temperature Range	$T_J$ , $T_{STG}$		-55 to 150		$^\circ C$
Maximum lead temperature for soldering purpose, 1/8" from case for 5 seconds	$T_L$		300		$^\circ C$

### Thermal Characteristics

Parameter	Symbol	AOT(B)12N65	AOTF12N65	AOTF12N65L	Units
Maximum Junction-to-Ambient <sup>A,D</sup>	$R_{\theta JA}$	65	65	65	$^\circ C/W$
Maximum Case-to-sink <sup>A</sup>	$R_{\theta CS}$	0.5	--	--	$^\circ C/W$
Maximum Junction-to-Case	$R_{\theta JC}$	0.45	2.5	3.1	$^\circ C/W$

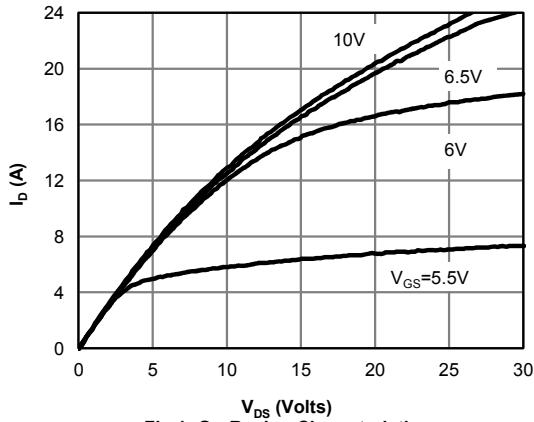
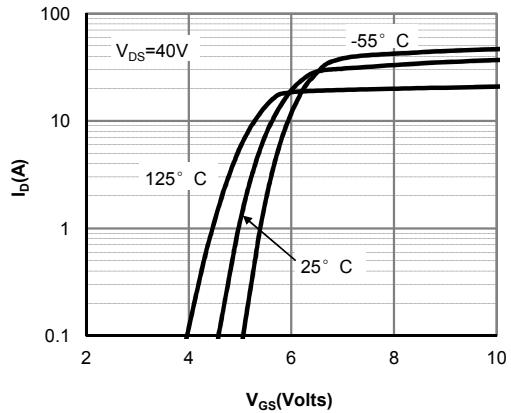
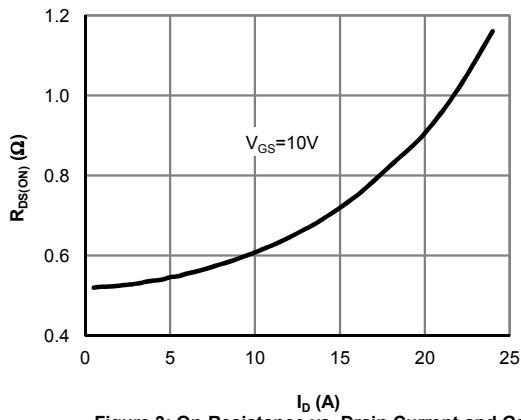
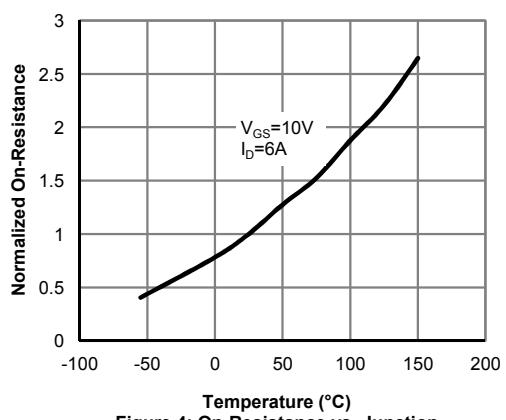
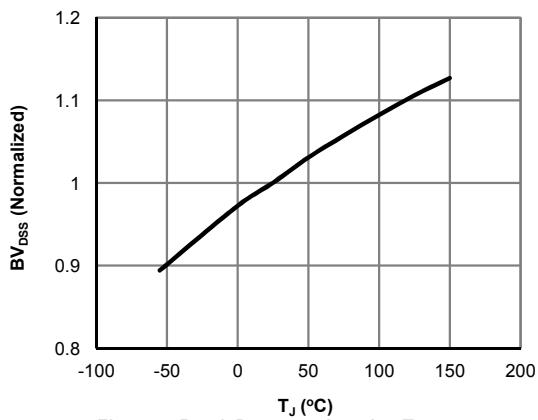
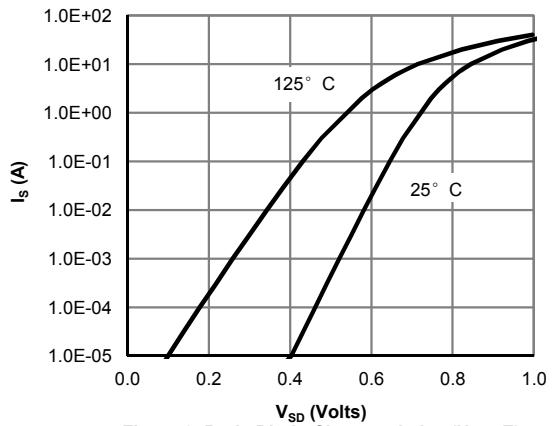
\* Drain current limited by maximum junction temperature.

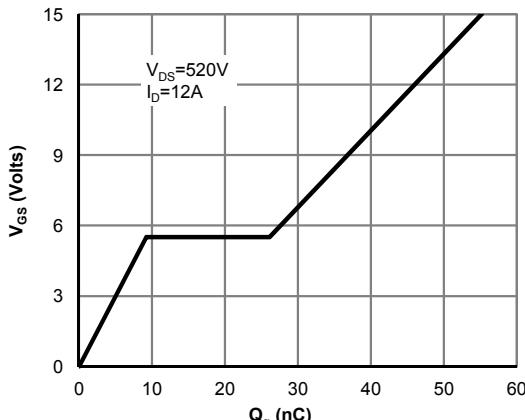
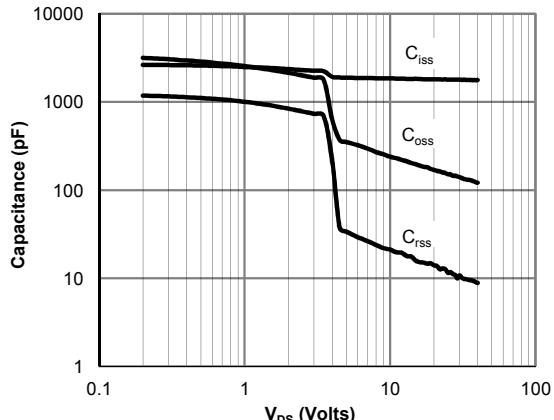
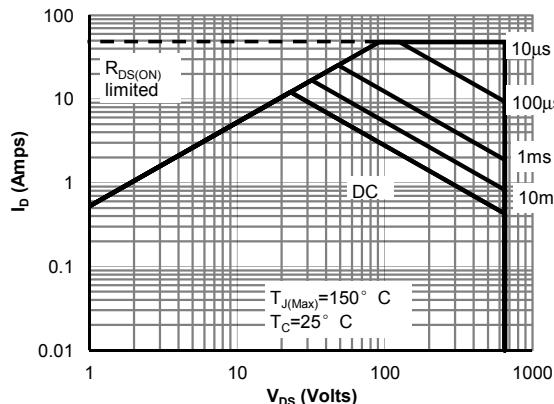
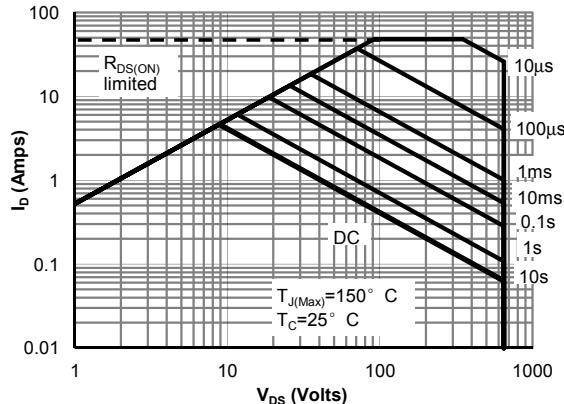
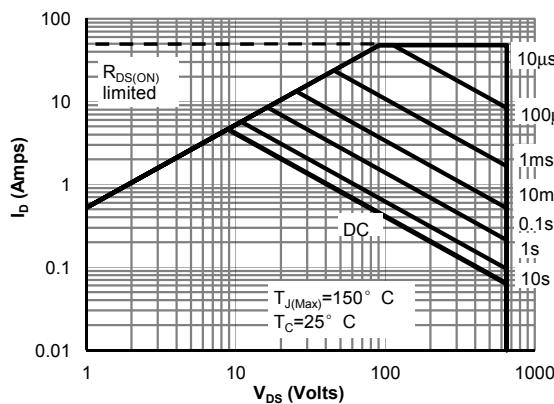
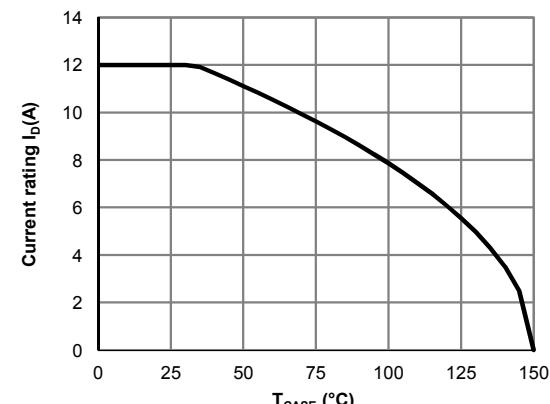
**Electrical Characteristics ( $T_J=25^\circ\text{C}$  unless otherwise noted)**

Symbol	Parameter	Conditions	Min	Typ	Max	Units
<b>STATIC PARAMETERS</b>						
$BV_{DSS}$	Drain-Source Breakdown Voltage	$I_D=250\mu\text{A}, V_{GS}=0\text{V}, T_J=25^\circ\text{C}$	650			V
		$I_D=250\mu\text{A}, V_{GS}=0\text{V}, T_J=150^\circ\text{C}$		750		
$BV_{DSS}/\Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D=250\mu\text{A}, V_{GS}=0\text{V}$		0.72		$\text{V}/^\circ\text{C}$
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS}=650\text{V}, V_{GS}=0\text{V}$		1		$\mu\text{A}$
		$V_{DS}=520\text{V}, T_J=125^\circ\text{C}$		10		
$I_{GSS}$	Gate-Body leakage current	$V_{DS}=0\text{V}, V_{GS}=\pm30\text{V}$			$\pm100$	nA
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{DS}=5\text{V}, I_D=250\mu\text{A}$	3	3.9	4.5	V
$R_{DS(\text{ON})}$	Static Drain-Source On-Resistance	$V_{GS}=10\text{V}, I_D=6\text{A}$		0.57	0.72	$\Omega$
$g_{FS}$	Forward Transconductance	$V_{DS}=40\text{V}, I_D=6\text{A}$		17		S
$V_{SD}$	Diode Forward Voltage	$I_S=1\text{A}, V_{GS}=0\text{V}$		0.71	1	V
$I_S$	Maximum Body-Diode Continuous Current				12	A
$I_{SM}$	Maximum Body-Diode Pulsed Current				48	A
<b>DYNAMIC PARAMETERS</b>						
$C_{iss}$	Input Capacitance	$V_{GS}=0\text{V}, V_{DS}=25\text{V}, f=1\text{MHz}$	1430	1792	2150	pF
$C_{oss}$	Output Capacitance		120	152	185	pF
$C_{rss}$	Reverse Transfer Capacitance		9	11.5	18	pF
$R_g$	Gate resistance	$V_{GS}=0\text{V}, V_{DS}=0\text{V}, f=1\text{MHz}$	1.7	3.5	5.3	$\Omega$
<b>SWITCHING PARAMETERS</b>						
$Q_g$	Total Gate Charge	$V_{GS}=10\text{V}, V_{DS}=520\text{V}, I_D=12\text{A}$	32	39.8	48	nC
$Q_{gs}$	Gate Source Charge		7.5	9.2	11	nC
$Q_{gd}$	Gate Drain Charge		13.5	16.8	20	nC
$t_{D(\text{on})}$	Turn-On DelayTime	$V_{GS}=10\text{V}, V_{DS}=325\text{V}, I_D=12\text{A}, R_G=25\Omega$		36		ns
$t_r$	Turn-On Rise Time			77		ns
$t_{D(\text{off})}$	Turn-Off DelayTime			120		ns
$t_f$	Turn-Off Fall Time			63		ns
$t_{rr}$	Body Diode Reverse Recovery Time	$I_F=12\text{A}, dI/dt=100\text{A}/\mu\text{s}, V_{DS}=100\text{V}$	300	375	450	ns
$Q_{rr}$	Body Diode Reverse Recovery Charge	$I_F=12\text{A}, dI/dt=100\text{A}/\mu\text{s}, V_{DS}=100\text{V}$	6	7.5	9	$\mu\text{C}$

- A. The value of  $R_{\text{GA}}$  is measured with the device in a still air environment with  $T_A=25^\circ\text{C}$ .  
B. The power dissipation  $P_D$  is based on  $T_{J(\text{MAX})}=150^\circ\text{C}$ , using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.  
C. Repetitive rating, pulse width limited by junction temperature  $T_{J(\text{MAX})}=150^\circ\text{C}$ . Ratings are based on low frequency and duty cycles to keep initial  $T_J=25^\circ\text{C}$ .  
D. The  $R_{\text{GA}}$  is the sum of the thermal impedance from junction to case  $R_{\text{AC}}$  and case to ambient.  
E. The static characteristics in Figures 1 to 6 are obtained using  $<300\ \mu\text{s}$  pulses, duty cycle 0.5% max.  
F. These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of  $T_{J(\text{MAX})}=150^\circ\text{C}$ . The SOA curve provides a single pulse rating.  
G.  $L=60\text{mH}$ ,  $I_{AS}=5\text{A}$ ,  $V_{DD}=150\text{V}$ ,  $R_G=25\Omega$ , Starting  $T_J=25^\circ\text{C}$

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**TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS**

**Fig 1: On-Region Characteristics**

**Figure 2: Transfer Characteristics**

**Figure 3: On-Resistance vs. Drain Current and Gate Voltage**

**Figure 4: On-Resistance vs. Junction Temperature**

**Figure 5: Break Down vs. Junction Temperature**

**Figure 6: Body-Diode Characteristics (Note E)**

**TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS**

**Figure 7: Gate-Charge Characteristics**

**Figure 8: Capacitance Characteristics**

**Figure 9: Maximum Forward Biased Safe Operating Area for AOT(B)12N65 (Note F)**

**Figure 10: Maximum Forward Biased Safe Operating Area for AOTF12N65 (Note F)**

**Figure 11: Maximum Forward Biased Safe Operating Area for AOTF12N65L (Note F)**

**Figure 12: Current De-rating (Note B)**

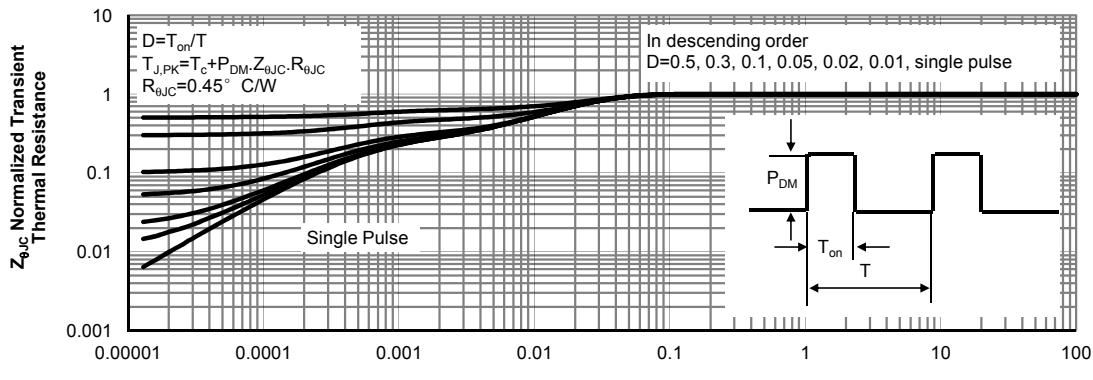
**TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS**


Figure 13: Normalized Maximum Transient Thermal Impedance for AOT(B)12N65 (Note F)

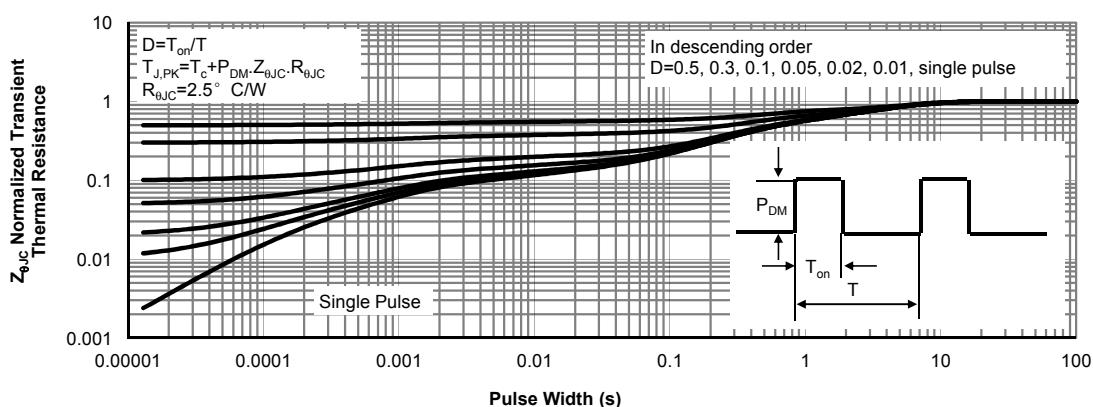


Figure 14: Normalized Maximum Transient Thermal Impedance for AOTF12N65 (Note F)

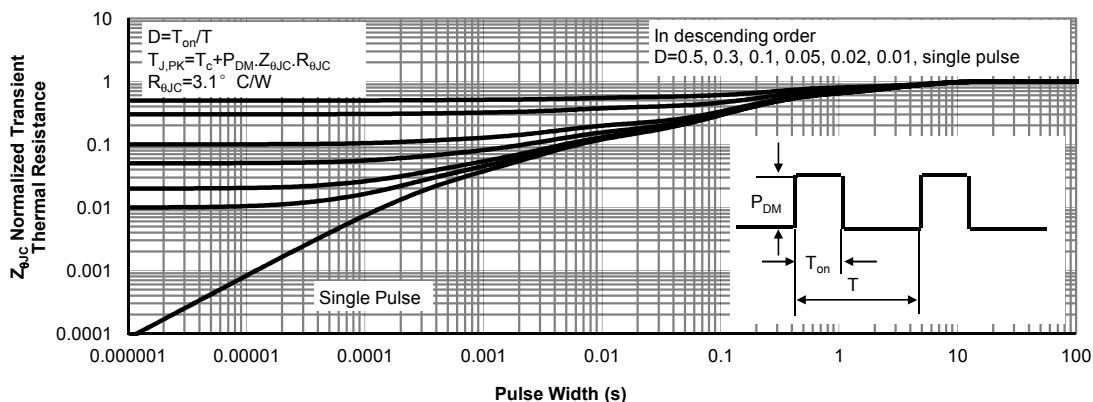
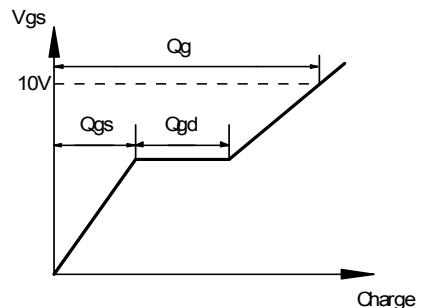
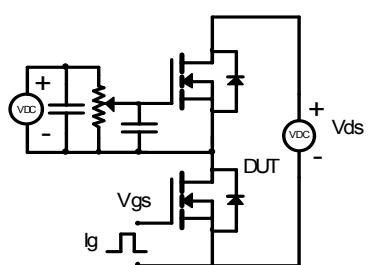
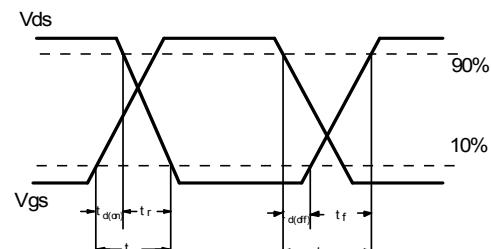
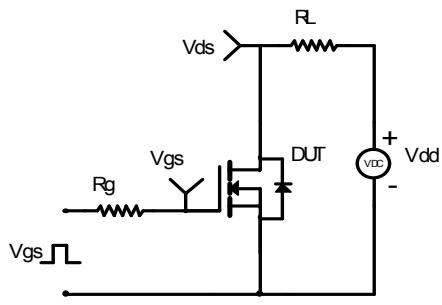
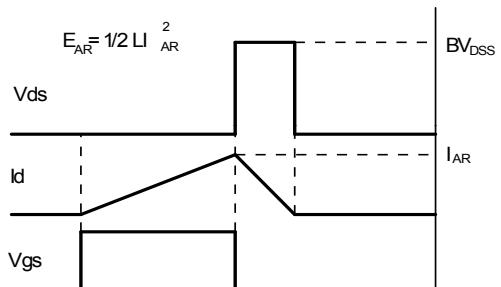
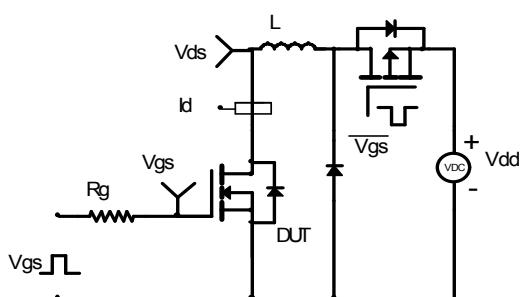
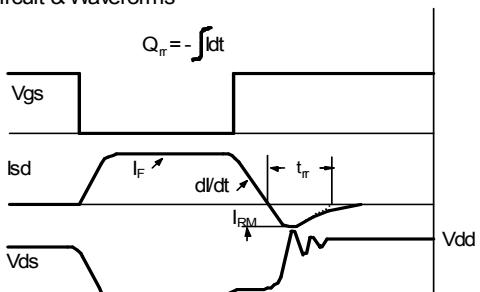
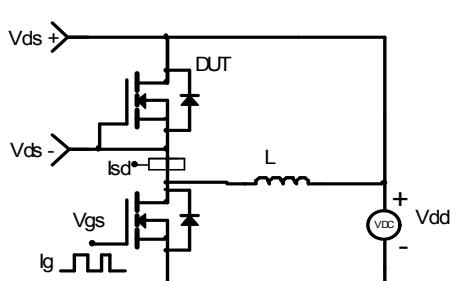


Figure 15: Normalized Maximum Transient Thermal Impedance for AOTF12N65L (Note F)

**Gate Charge Test Circuit & Waveform**

**Resistive Switching Test Circuit & Waveforms**

**Unclamped Inductive Switching (UIS) Test Circuit & Waveforms**

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